THE DATASHEET OF

EL1881CSZ

EL1881

Sync Separator, Low Power

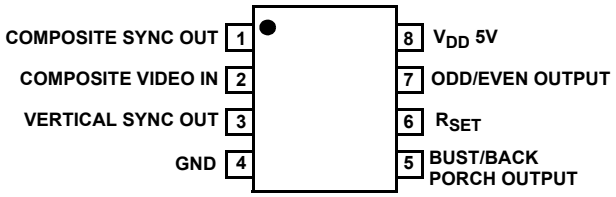
FN7018
Rev 2.00
September 15, 2011

The EL1881 video sync separator is manufactured using Elantec's high performance analog CMOS process. This device extracts sync timing information from both standard and non-standard video input. It provides composite sync, vertical sync, burst/back porch timing, and odd/even field detection. Fixed 70mV sync tip slicing provides sync edge detection when the video input level is between $0.5V_{P-P}$ and $-2V_{P-P}$ (sync tip amplitude 143mV to 572mV). A single external resistor sets all internal timing to adjust for various video standards. The composite sync output follows video in sync pulses and a vertical sync pulse is output on the rising edge of the first vertical serration following the vertical pre-equalizing string. For non-standard vertical inputs, a default vertical pulse is output when the vertical signal stays low for longer than the vertical sync default delay time. The odd/even output indicates field polarity detected during the vertical blanking interval. The EL1881 is plug-in compatible with the industry-standard LM1881 and can be substituted for that part in 5V applications with lower required supply current.

The EL1881 is available in the 8 Ld PDIP and SOIC packages and is specified for operation over the full -40°C to +85°C temperature range

Pinout

EL1881
(8 LD PDIP, SOIC)
TOP VIEW



Features

- NTSC, PAL, SECAM, non-standard video sync separation
- Fixed 70mV slicing of video input levels from $0.5V_{P-P}$ to $2V_{P-P}$
- Low supply current - 1.5mA typ.
- Single +5V supply
- Composite, vertical sync output
- Odd/even field output
- Burst/back porch output
- Available in 8 Ld PDIP and SOIC packages
- Pb-free available (RoHS Compliant)

Applications

- Video amplifiers
- PCMCIA applications
- A/D drivers
- Line drivers
- Portable computers
- High-speed communications
- RGB applications
- Broadcast equipment
- Active filtering

Demo Board

A dedicated demo board is available.

Pin Descriptions

PIN NUMBER	PIN NAME	PIN FUNCTION
1	Composite Sync Out	Composite sync pulse output; sync pulses start on a falling edge and end on a rising edge
2	Composite Video In	AC coupled composite video input; sync tip must be at the lowest potential (positive picture phase)
3	Vertical Sync Out	Vertical sync pulse output; the falling edge of vert sync is the start of the vertical period
4	GND	Supply ground
5	Burst/Back Porch Output	Burst/back porch output; low during burst portion of composite video
6	R_{SET} (Note 1)	An external resistor to ground sets all internal timing; a 681k 1% resistor will provide correct timing for NTSC signals
7	Odd/Even Output	Odd/even field output; high during odd fields, low during even fields; transitions occur at start of vert sync pulse
8	VDD 5V	Positive supply (5V)

NOTE:

1. R_{SET} must be a 1% resistor

Ordering Information

PART NUMBER	PART MARKING	PACKAGE	PKG. DWG. #
EL1881CN	EL1881CN	8 Ld PDIP	E8.3
EL1881CS	1881CS	8 Ld SOIC	M8.15E
EL1881CS-T7 (Note 2)	1881CS	8 Ld SOIC (Tape & Reel)	M8.15E
EL1881CSZ (Notes 3, 4)	1881CSZ	8 Ld SOIC (Pb-free)	M8.15E
EL1881CSZ-T7 (Notes 2, 3, 4)	1881CSZ	8 Ld SOIC (Pb-free, Tape & Reel)	M8.15E
EL1881CSZ-T13 (Notes 2, 3, 4))	1881CSZ	8 Ld SOIC (Pb-free, Tape & Reel)	M8.15E

NOTES:

2. Please refer to TB347 for details on reel specifications.
3. These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
4. For Moisture Sensitivity Level (MSL), please see device information page for EL1881. For more information on MSL, please see Technical Brief TB363.

Absolute Maximum Ratings (T_A = +25°C)

V_{CC} Supply 7V
Storage Temperature . . . . . -65°C to +150°C
Pin Voltages . . . . . -0.5V to V_{CC} +0.5V

Thermal Information

Thermal Resistance (Typical, Note 5)	θ_{JA} (°C/W)
8 Lead PDIP	85
8 Lead SOIC	95 to 120

Operating Ambient Temperature Range . . . . . -40°C to +85°C
Operating Junction Temperature . . . . . 150°C
Power Dissipation 400mW

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

NOTE:

5. θ_{JA} is measured with the component mounted on a high effective thermal conductivity test board in free air. See Tech Brief TB379 for details.

IMPORTANT NOTE: All parameters having Min/Max specifications are guaranteed. Typical values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore: $T_J = T_C = T_A$

DC Electrical Specifications

V_{DD} = 5V, T_A = +25°C, R_{SET} = 681kΩ, unless otherwise specified.

PARAMETER	DESCRIPTION	MIN	TYP	MAX	UNIT
I_{DD}, Quiescent	V_{DD} = 5V	0.75	1.5	3	mA
Clamp Voltage	Pin 2, I_{LOAD} = -100µA	1.35	1.5	1.65	V
Clamp Discharge Current	Pin 2 = 2V	6	12	16	µA
Clamp Charge Current	Pin 2 = 1V	-1.3	-1	0.7	mA
R_{SET} Pin Reference Voltage	Pin 6	1.1	1.22	1.35	V
V_{OL} Output Low Voltage	I_{OL} = 1.6mA		0.24	0.5	V
V_{OH} Output High Voltage	I_{OH} = -40µA	4	4.8		V
	I_{OH} = -1.6mA	3	4.6		V

Dynamic Specifications

PARAMETER	DESCRIPTION	MIN	TYP	MAX	UNIT
Comp Sync Prop Delay, t_{CS}	See Figure 20	20	35	75	ns
Vertical Sync Width, t_{VS}	Normal or Default Trigger, 50% to 50%	190	230	300	µs
Vertical Sync Default Delay, t_{VSD}	See Figure 21	35	62	85	µs
Burst/Back Porch Delay, t_{BD}	See Figure 20	120	200	300	ns
Burst/Back Porch Width, t_B	See Figure 20	2.5	3.5	4.5	µs
Input Dynamic Range	Video Input Amplitude to Maintain 50% Slice Spec	0.5		2	V_{P-P}
Slice Level	V_{SLICE}/V_{CLAMP}	55	70	85	mV

Typical Performance Curves

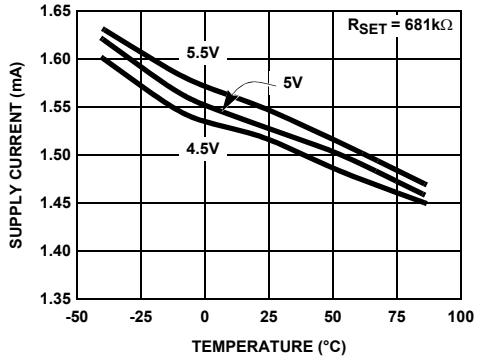


FIGURE 1. SUPPLY CURRENT vs TEMPERATURE

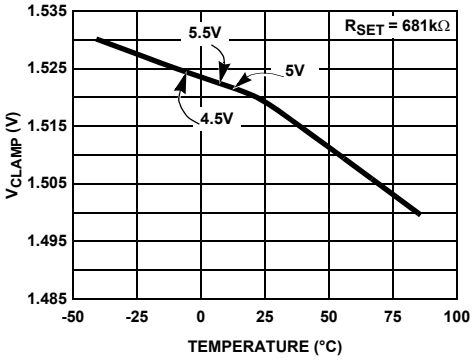


FIGURE 2. V_{CLAMP} VOLTAGE vs TEMPERATURE

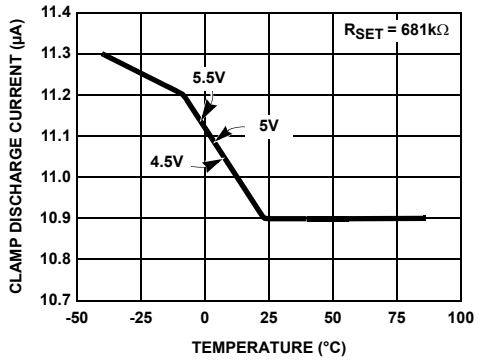


FIGURE 3. CLAMP DISCHARGE CURRENT vs TEMPERATURE

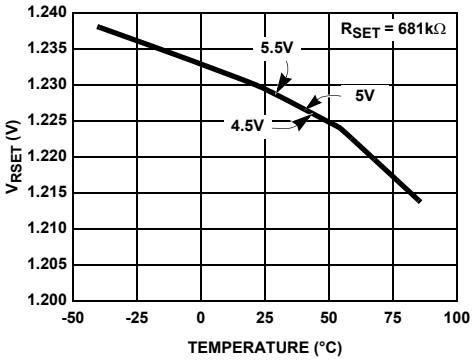


FIGURE 4. V_{RSET} vs TEMPERATURE

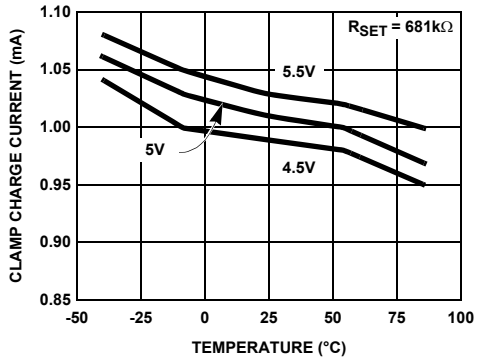


FIGURE 5. CLAMP CHARGE CURRENT vs TEMPERATURE

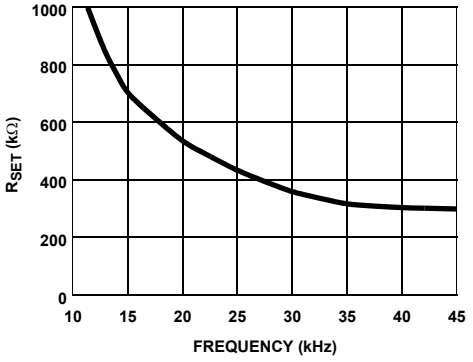


FIGURE 6. R_{SET} vs HORIZONTAL FREQUENCY

Typical Performance Curves (Continued)

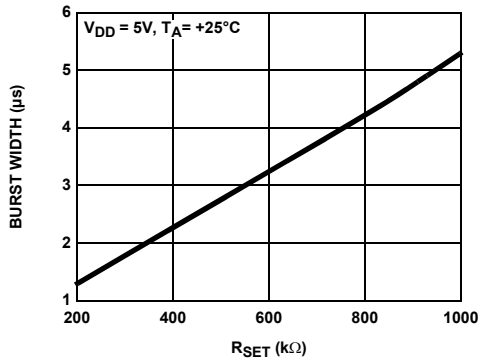


FIGURE 7. BURST/BACK PORCH WIDTH vs R_{SET}

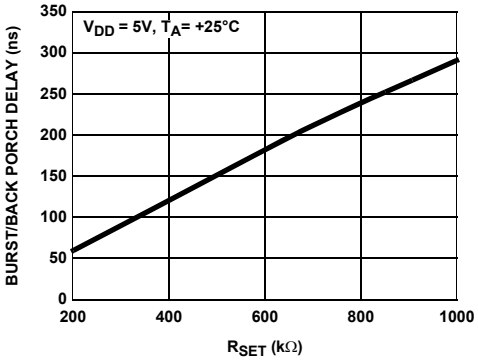


FIGURE 8. BURST/BACK PORCH DELAY vs R_{SET}

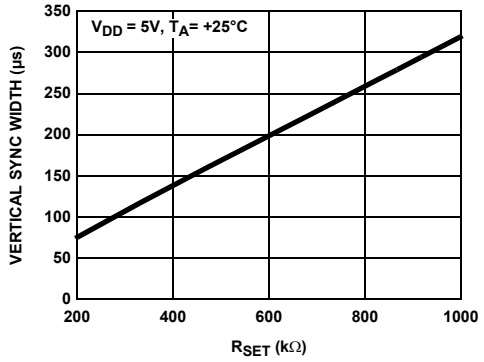


FIGURE 9. VERTICAL SYNC WIDTH vs R_{SET}

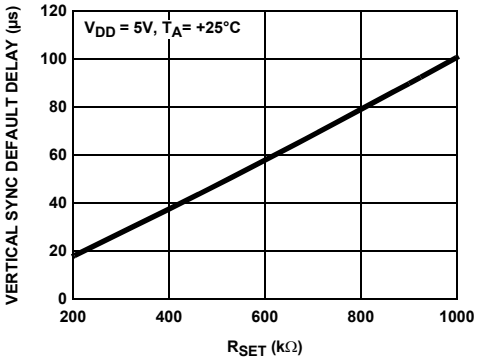


FIGURE 10. VERTICAL DEFAULT DELAY vs R_{SET}

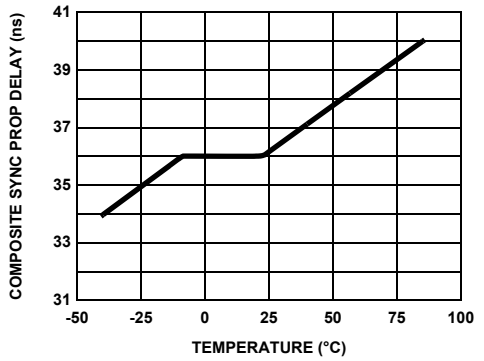


FIGURE 11. COMPOSITE SYNC PROP DELAY vs TEMPERATURE

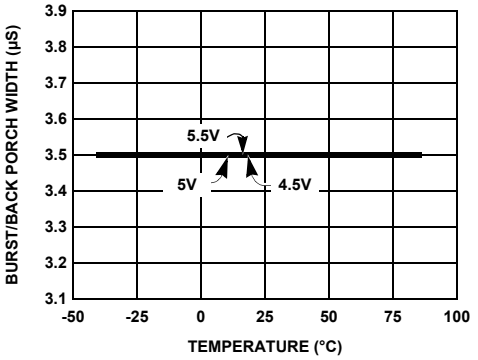


FIGURE 12. BURST/BACK PORCH WIDTH vs TEMPERATURE

Typical Performance Curves (Continued)

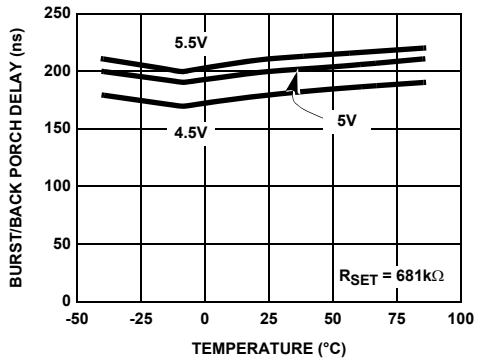


FIGURE 13. BURST/BACK PORCH DELAY vs TEMPERATURE

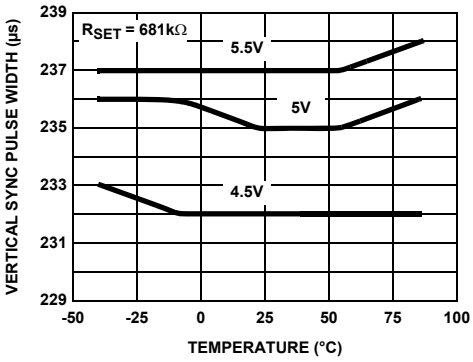


FIGURE 14. VERTICAL SYNC PULSE WIDTH vs TEMPERATURE

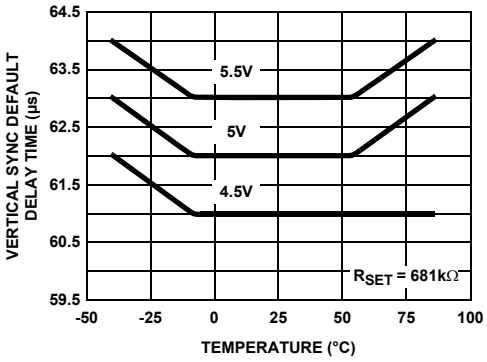


FIGURE 15. VERTICAL SYNC DEFAULT DELAY TIME vs TEMPERATURE

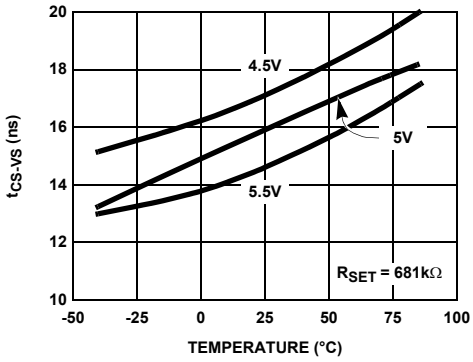


FIGURE 16. COMPOSITE SYNC TO VERTICAL SYNC DELAY TIME

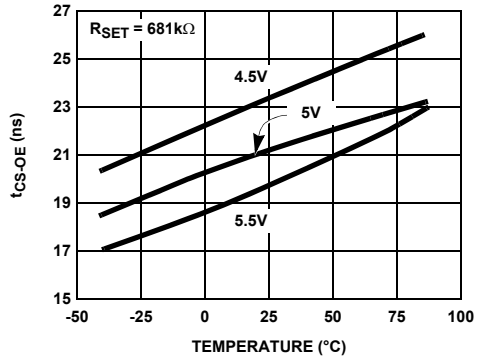


FIGURE 17. COMPOSITE SYNC TO ODD/EVEN DELAY TIME

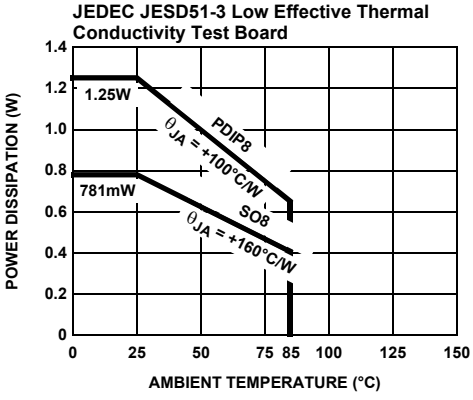
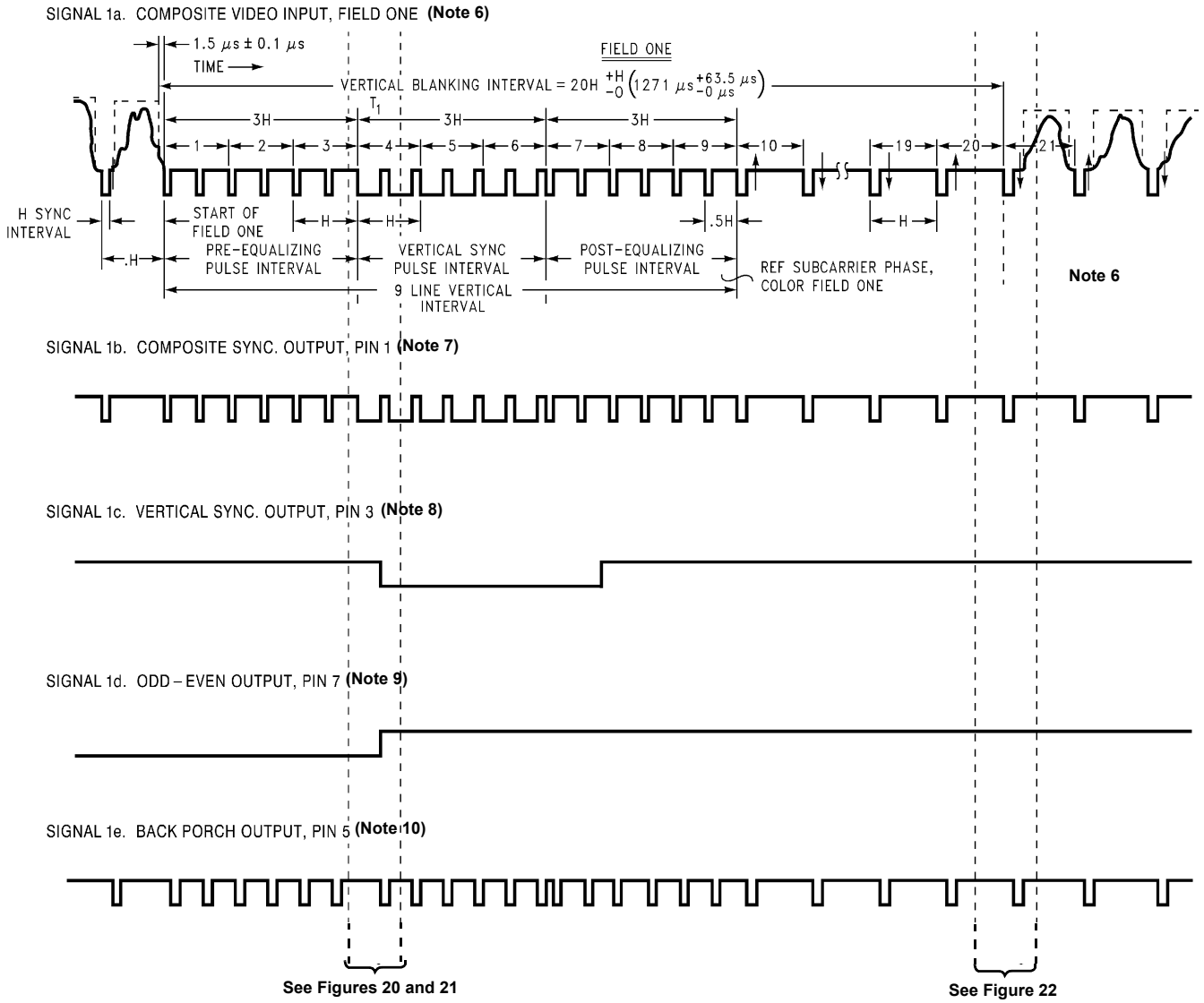


FIGURE 18. PACKAGE POWER DISSIPATION vs AMBIENT TEMPERATURE

Timing Diagrams



NOTES:

6. Signal 1a drawing reproduced with permission from EIA.
7. The composite sync output reproduces all the video input sync pulses, with a propagation delay.
8. Vertical sync leading edge is coincident with the first vertical serration pulse leading edge, with a propagation delay.
9. Odd-even output is low for even field, and high for odd field.
10. Back porch goes low for a fixed pulse width on the trailing edge of video input sync pulses. Note that for serration pulses during vertical, the back porch starts on the rising edge of the serration pulse (with propagation delay).

FIGURE 19. STANDARD (NTSC INPUT) TIMING

Expanded Timing Diagrams

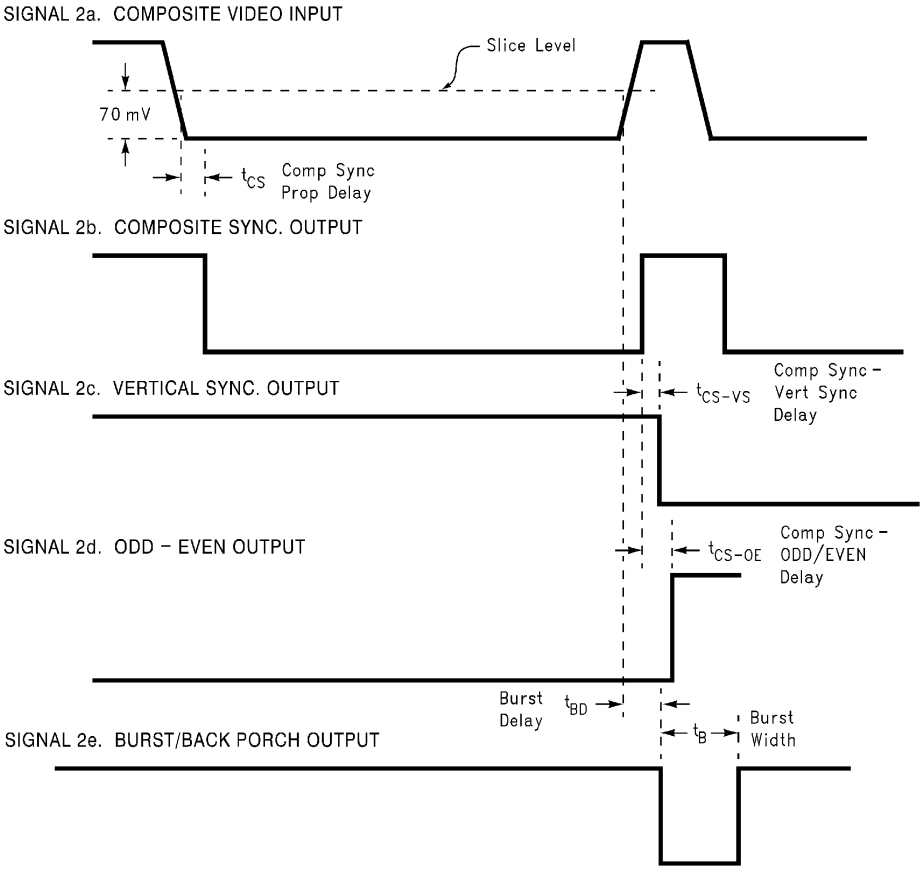


FIGURE 20. STANDARD VERTICAL TIMING

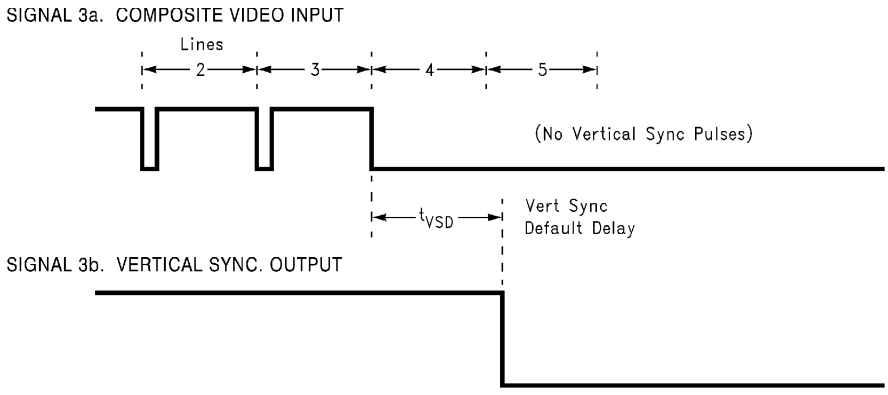


FIGURE 21. NON-STANDARD VERTICAL TIMING

Expanded Timing Diagrams (Continued)

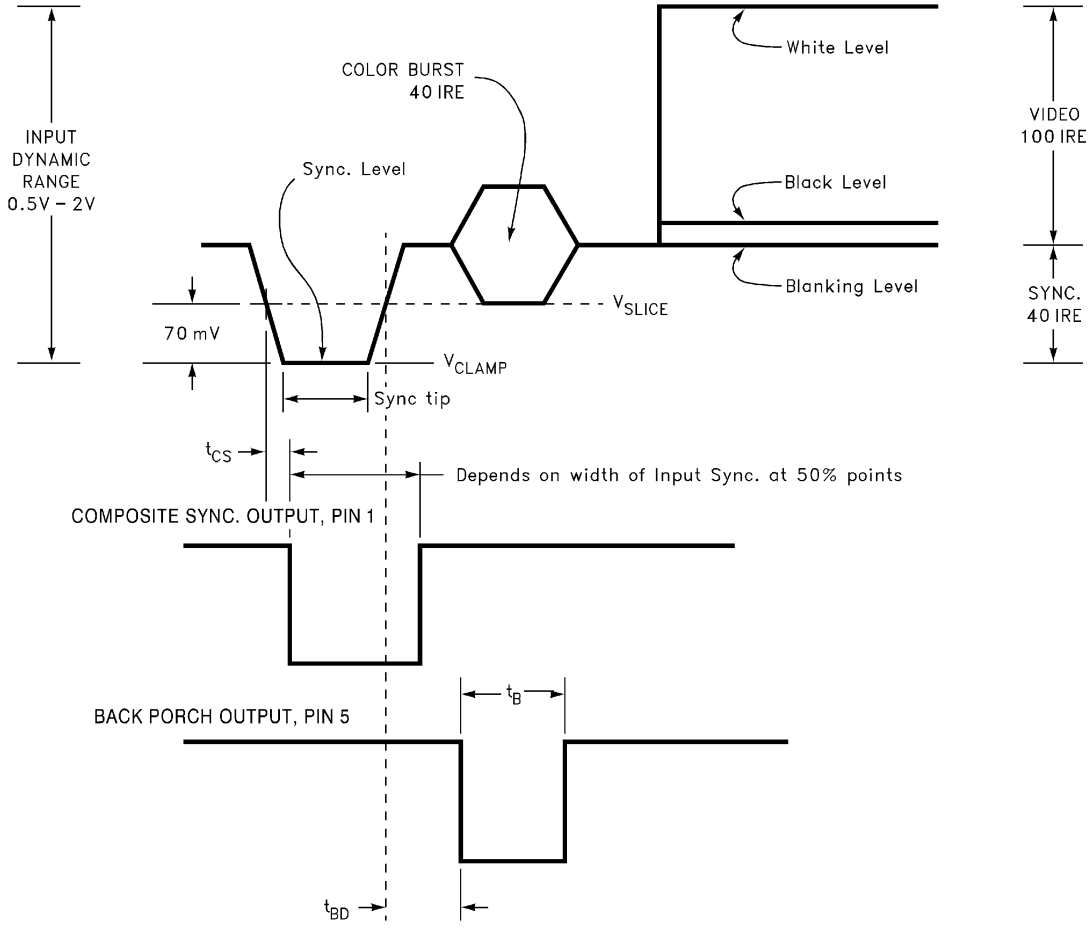


FIGURE 22. STANDARD VERTICAL TIMING

Applications Information

Video In

Figure 24 shows a “Simplified Block Diagram” on page 11.

An AC-coupled video signal is input to Video In pin 2 via, C_1 nominally 0.1µF. Clamp charge current will prevent the signal on pin 2 from going any more negative than Sync Tip Ref, about 1.5V. This charge current is nominally about 1mA. A clamp discharge current of about 10µA is always attempting to discharge C_1 to Sync Tip Ref, thus charge is lost between sync pulses that must be replaced during sync pulses. The droop voltage that will occur can be calculated from It = CV, where V is the droop voltage, I is the discharge current, t is the time between sync pulses (sync period - sync tip width), and C is C_1.

An NTSC video signal has a horizontal frequency of 15.73kHz, and a sync tip width of 4.7µs. This gives a period of 63.6µs and a time t = 58.9µs. The droop voltage will then be V = 5.9mV. This is < 2% of a nominal sync tip amplitude of 286mV. The charge represented by this droop is replaced in a time given by t = CV/I, where I = clamp charge current = 1mA. Here t = 590ns, about 12% of the sync pulse width of 4.7µs. It is important to choose C_1 large enough so that the droop voltage does not approach the switching threshold of the internal comparator.

Fixed Gain Buffer

The clamped video signal then passes to the fixed gain buffer which places the sync slice level at the equivalent level of 70mV above sync tip. The output of this buffer is presented to the comparator, along with the slice reference. The comparator output is level shifted and buffered to TTL levels, and sent out as Composite Sync to pin 1.

Burst

A low-going Burst pulse follows each rising edge of sync, and lasts approximately 3.5µs for an R_{SET} of 681kΩ.

Vertical Sync

A low-going Vertical Sync pulse is output during the start of the vertical cycle of the incoming video signal. The vertical cycle starts with a pre-equalizing phase of pulses with a duty cycle of about 93%, followed by a vertical serration phase

that has a duty cycle of about 15%. Vertical Sync is clocked out of the EL1881 on the first rising edge during the vertical serration phase. In the absence of vertical serration pulses, a vertical sync pulse will be forced out after the vertical sync default delay time, approximately 60µs after the last falling edge of the vertical equalizing phase for R_{SET} = 681kΩ.

Odd/Even

Because a typical television picture is composed of two interlaced fields, there is an odd field that includes all the odd lines, and an even field that consists of the even lines. This odd/even field information is decoded by the EL1881 during the end of picture information and the beginning of vertical information. The odd/even circuit includes a T-flip-flop that is reset during full horizontal lines, but not during half lines or vertical equalization pulses. The T-flip-flop is clocked during each falling edge of these half-period pulses. Even fields will toggle until a low state is clocked to the odd/even pin 7 at the beginning of vertical sync, and odd fields will cause a high state to be clocked to the odd/even pin at the start of the next vertical sync pulse. Odd/even can be ignored if using non-interlaced video, as there is no change in timing from one field to the next.

R_{SET}

An external R_{SET} resistor, connected from R_{SET} pin 6 to ground, produces a reference current that is used internally as the timing reference for vertical sync width, vertical sync default delay, burst gate delay and burst width. Decreasing the value of R_{SET} increases the reference current, which in turn decreases reference times and pulse widths. A higher frequency video input necessitates a lower R_{SET} value.

Chroma Filter

A chroma filter is suggested to increase the S/N ratio of the incoming video signal. Use of the optional chroma filter is shown in Figure 23. It can be implemented very simply and inexpensively with a series resistor of 620Ω and a parallel capacitor of 500pF, which gives a single pole roll-off frequency of about 500kHz. This sufficiently attenuates the 3.58MHz (NTSC) or 4.43MHz (PAL) color burst signal, yet passes the approximately 15kHz sync signals without appreciable attenuation. A chroma filter will increase the propagation delay from the composite input to the outputs.

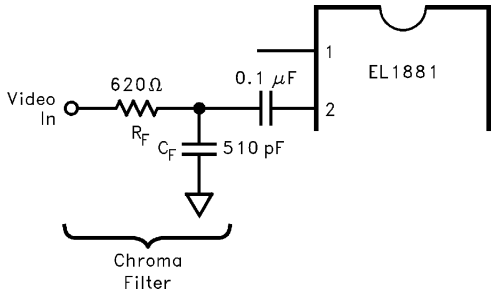
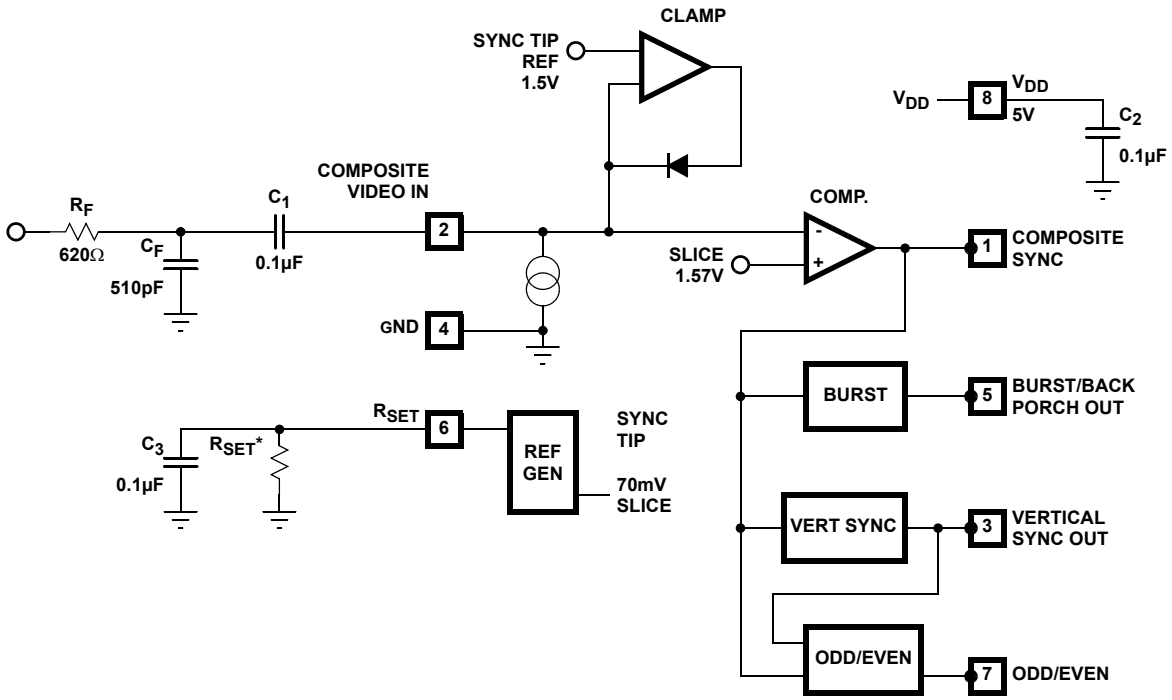


FIGURE 23.

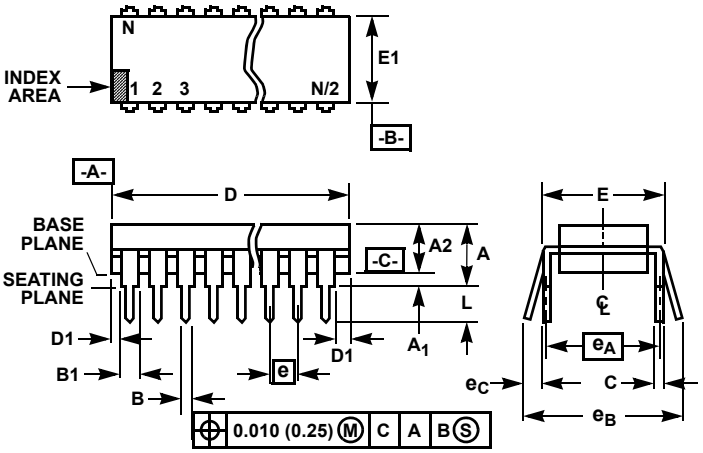
Simplified Block Diagram



NOTE: * R_{SET} MUST BE AT 1% RESISTOR

FIGURE 24.

Dual-In-Line Plastic Packages (PDIP)



NOTES:

1. Controlling Dimensions: INCH. In case of conflict between English and Metric dimensions, the inch dimensions control.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Symbols are defined in the “MO Series Symbol List” in Section 2.2 of Publication No. 95.
4. Dimensions A, A1 and L are measured with the package seated in JEDEC seating plane gauge GS-3.
5. D, D1, and E1 dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010 inch (0.25mm).
6. E and e_A are measured with the leads constrained to be perpendicular to datum -C-.
7. e_B and e_C are measured at the lead tips with the leads unconstrained. e_C must be zero or greater.
8. B1 maximum dimensions do not include dambar protrusions. Dambar protrusions shall not exceed 0.010 inch (0.25mm).
9. N is the maximum number of terminal positions.
10. Corner leads (1, N, N/2 and N/2 + 1) for E8.3, E16.3, E18.3, E28.3, E42.6 will have a B1 dimension of 0.030 - 0.045 inch (0.76 - 1.14mm).

E8.3 (JEDEC MS-001-BA ISSUE D)
8 LEAD DUAL-IN-LINE PLASTIC PACKAGE

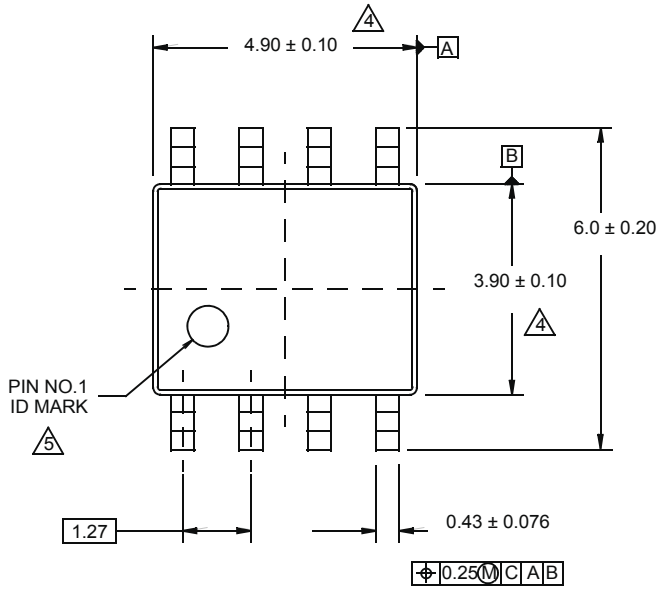
SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	-	0.210	-	5.33	4
A1	0.015	-	0.39	-	4
A2	0.115	0.195	2.93	4.95	-
B	0.014	0.022	0.356	0.558	-
B1	0.045	0.070	1.15	1.77	8, 10
C	0.008	0.014	0.204	0.355	-
D	0.355	0.400	9.01	10.16	5
D1	0.005	-	0.13	-	5
E	0.300	0.325	7.62	8.25	6
E1	0.240	0.280	6.10	7.11	5
e	0.100 BSC		2.54 BSC		-
e_A	0.300 BSC		7.62 BSC		6
e_B	-	0.430	-	10.92	7
L	0.115	0.150	2.93	3.81	4
N	8		8		9

Rev. 0 12/93

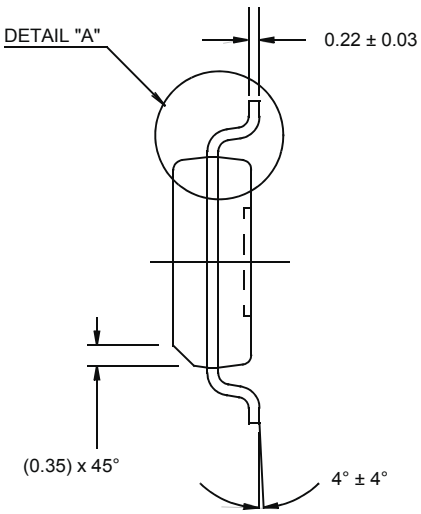
Package Outline Drawing

M8.15E

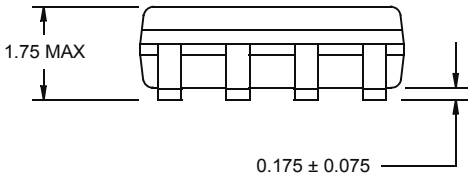
8 LEAD NARROW BODY SMALL OUTLINE PLASTIC PACKAGE
Rev 0, 08/09



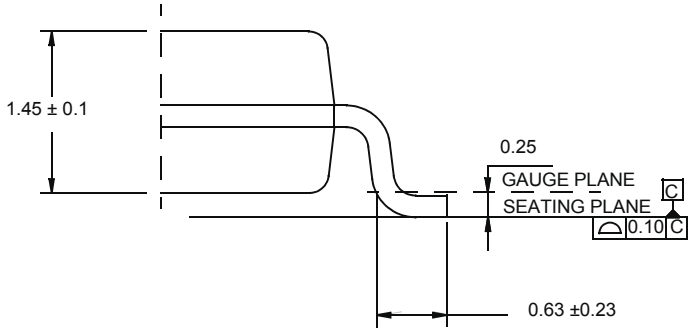
TOP VIEW



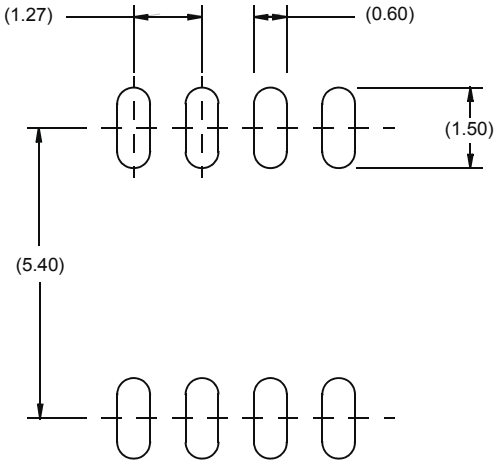
SIDE VIEW "B"



SIDE VIEW "A"



DETAIL "A"



TYPICAL RECOMMENDED LAND PATTERN

NOTES:

1. Dimensions are in millimeters.
   Dimensions in ( ) for Reference Only.
2. Dimensioning and tolerancing conform to AMSE Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal ± 0.05
4. Dimension does not include interlead flash or protrusions.
   Interlead flash or protrusions shall not exceed 0.25mm per side.
5. The pin #1 identifier may be either a mold or mark feature.
6. Reference to JEDEC MS-012.

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